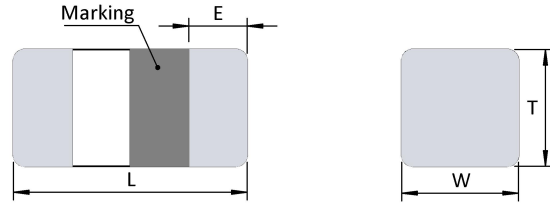
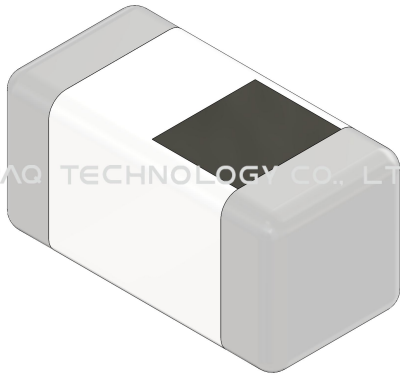


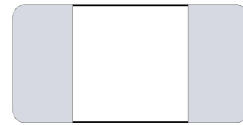
MCI1608HH8N2_HBP



Appearance & Shape



INPAQ TECHNOLOGY CO., LTD.



L	1.60±0.15
W	0.80±0.15
T	0.80±0.15
E	0.40±0.20

(unit:mm)

INPAQ TECHNOLOGY CO., LTD.



注意 NOTICE: All Specifications are subject to change without notice.

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2. 本文件僅說明參考標準規格，如需訂購，請依實際核准所需規格進行申辦。

Specification

L size(mm)	1.6±0.15
W size(mm)	0.8±0.15
T size(mm)	0.8±0.15
Size code Inch(mm)	0603(1608)
Inductance(nH)	8.2
Tolerance	J(±5%)
Test Frequency(MHz)	100
DCR(Ω) Max.	0.28
I _{rms} (mA) Max.	600
Q Value (Min.)	10
SRF(MHz) Min.	3500
Operating Temperature range(including self-temperature rising) °C	-55~+125

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Notices

- Particular ceramic material and coil structure provide high frequency application range up to 10GHz.
- Small size and low profile.
- Available in various sizes.
- Excellent solderability and heat resistance.

Packing

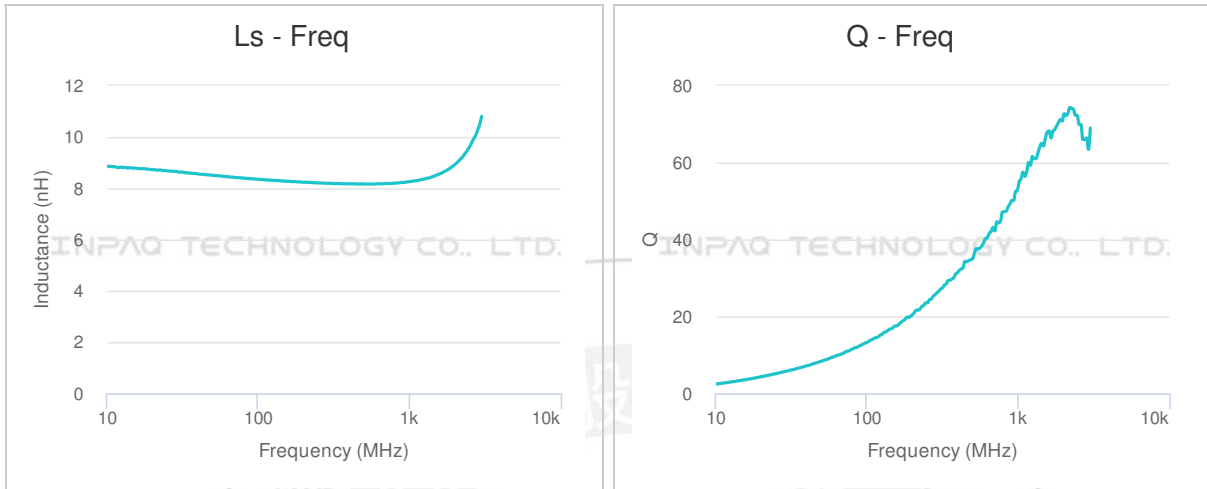
Packing Reel(Inch)	Packaging type	Standard package quantity(PCS)	Piece weight(gram)	MSL Level
7	Paper type	4000	0.0026	1

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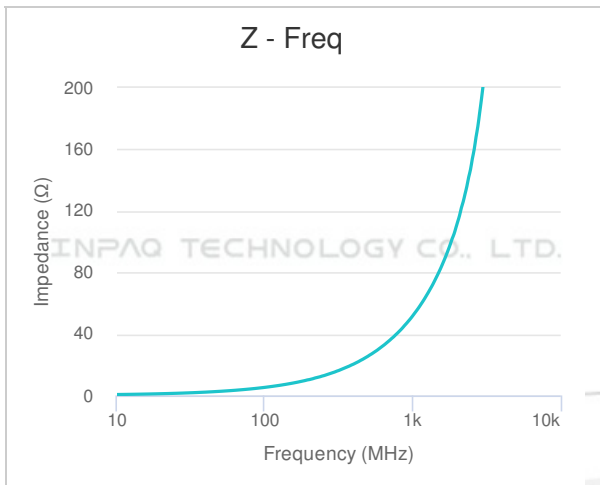
Characteristic curve



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